

30N06

Power MOSFET

60V, 30A N-CHANNEL POWER MOSFET

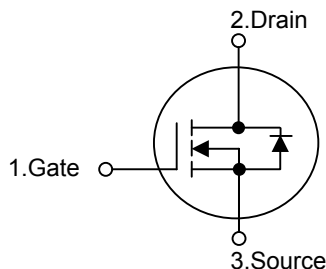
DESCRIPTION

The **30N06** is a low voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and excellent avalanche characteristics. This power MOSFET is usually used at automotive applications in power supplies, high efficient DC to DC converters and battery operated products.

FEATURES

- * $R_{DS(ON)} = 40m\Omega @ V_{GS} = 10V$
- * Ultra low gate charge (typical 20nC)
- * Low reverse transfer Capacitance ($C_{RSS} =$ typical 80 pF)
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability

SYMBOL

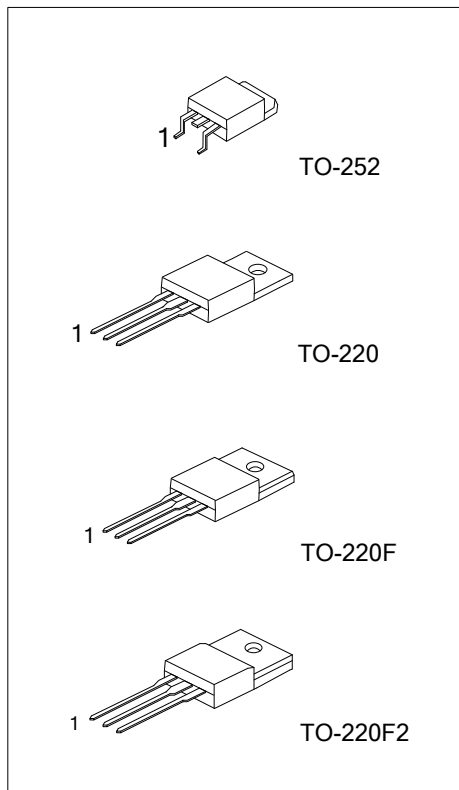


ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
30N06L-TA3-T	30N06G-TA3-T	TO-220	G	D	S	Tube
30N06L-TF2-T	30N06G-TF2-T	TO-220F2	G	D	S	Tube
30N06L-TF3-T	30N06G-TF3-T	TO-220F	G	D	S	Tube
30N06L-TN3-T	30N06G-TN3-T	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

30N06L-TA3-T (1)Packing Type (2)Package Type (3)Lead Free	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF2: TO-220F2, TF3: TO-220F, TN3: TO-252 (3) G: Halogen Free, L: Lead Free
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■ ABSOLUTE MAXIMUM RATINGS($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Gate to Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current	$T_c = 25^\circ\text{C}$	I_D	30	A
	$T_c = 100^\circ\text{C}$		21.3	A
Pulsed Drain Current (Note 2)		I_{DM}	120	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	300	mJ
	Repetitive (Note 2)	E_{AR}	8	mJ
Power Dissipation	TO-220	P_D	79	W
	TO-220F/ TO-220F2		45	
	TO-252		44	
Junction Temperature		T_J	+150	$^\circ\text{C}$
Operation Temperature		T_{OPR}	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repeativity rating: pulse width limited by junction temperature

3. $L=0.66\text{mH}$, $I_{AS}=30\text{A}$, $V_{DD}=25\text{V}$, $R_G=20\Omega$, Starting $T_J=25^\circ\text{C}$

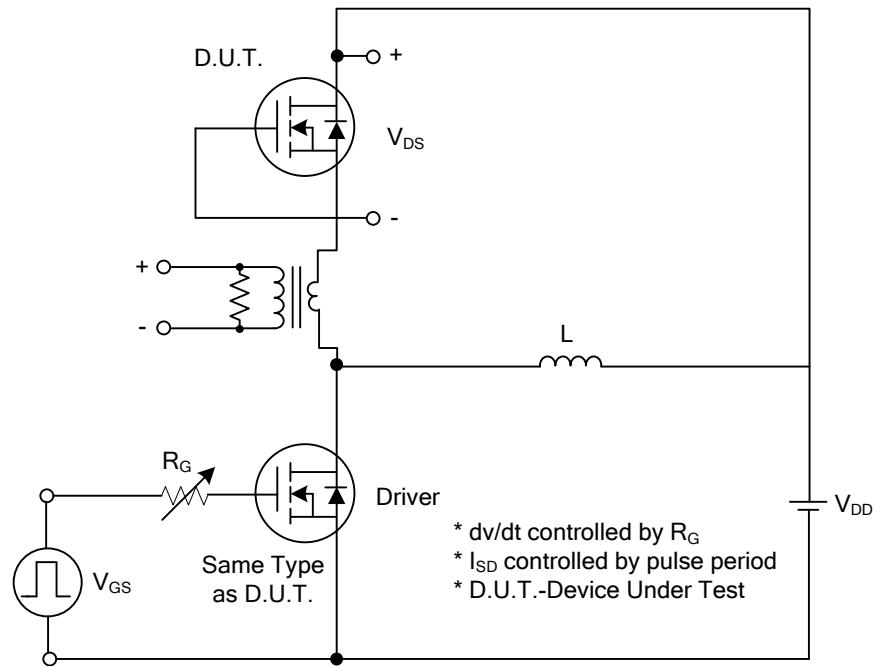
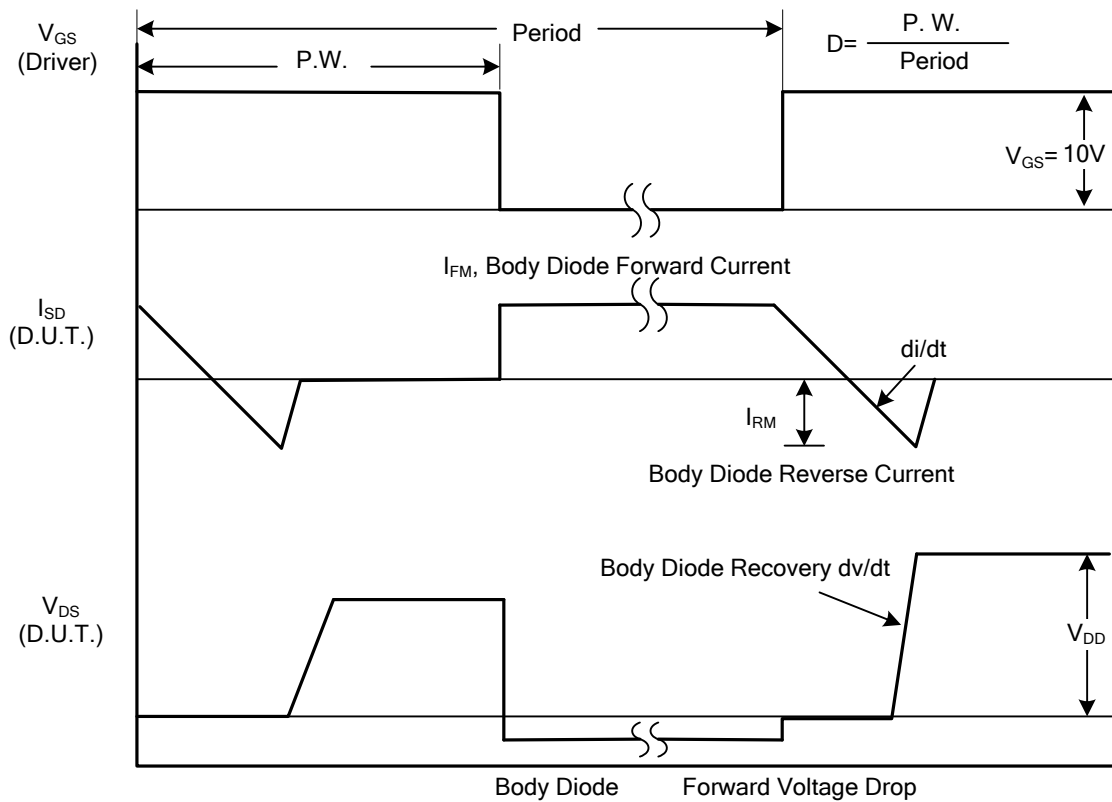
■ THERMAL DATA

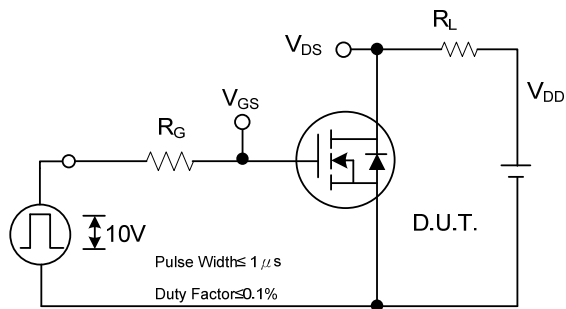
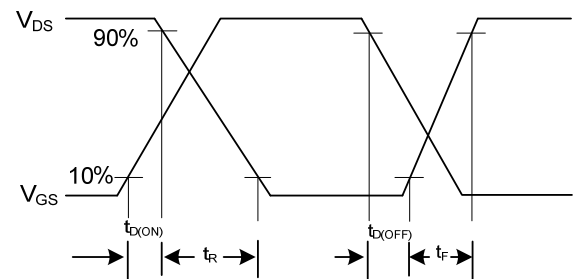
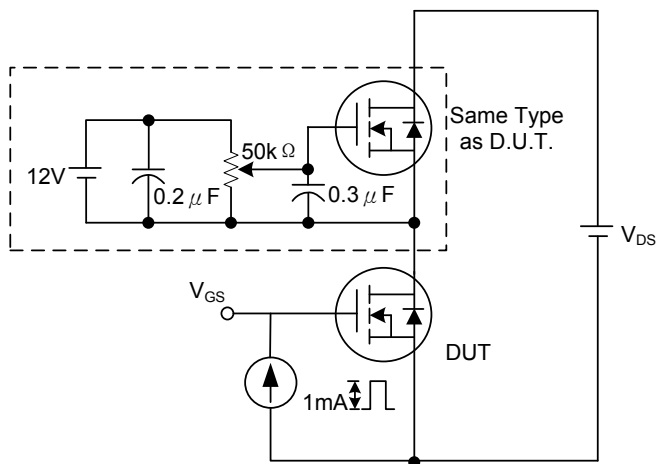
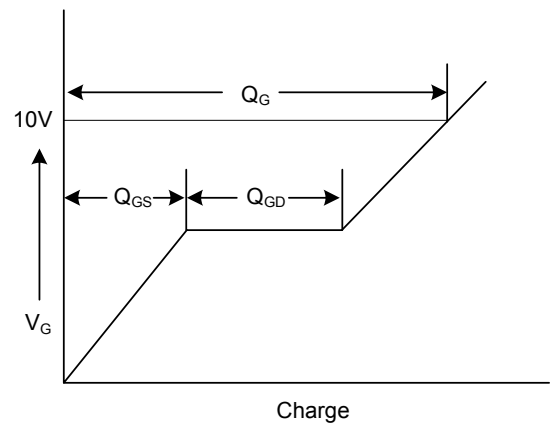
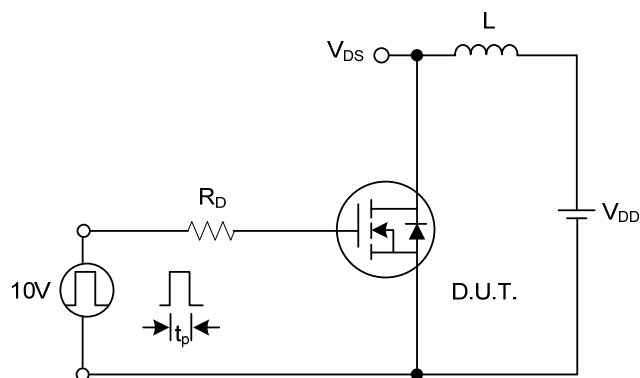
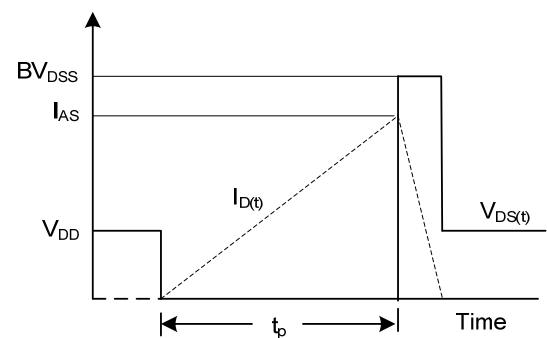
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220	θ_{JA}	62	$^\circ\text{C/W}$
	TO-220F/TO-220F2		62.5	
	TO-252		110	
Junction to Case	TO-220	θ_{JC}	1.9	$^\circ\text{C/W}$
	TO-220F/TO-220F2		2.7	
	TO-252		2.85	

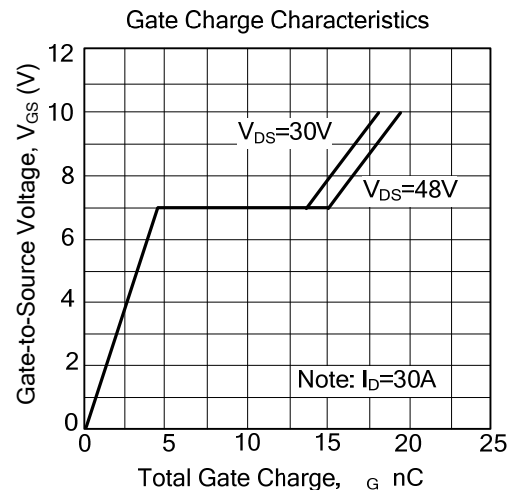
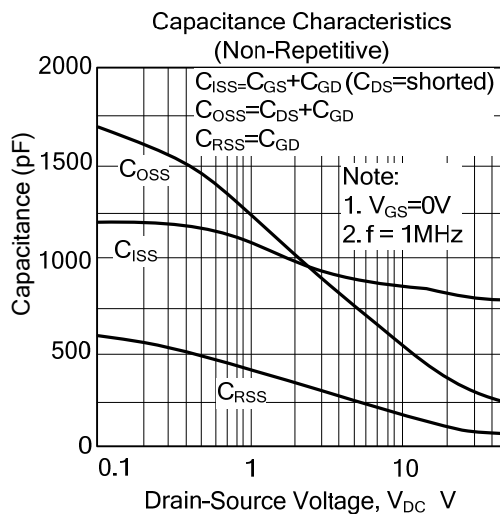
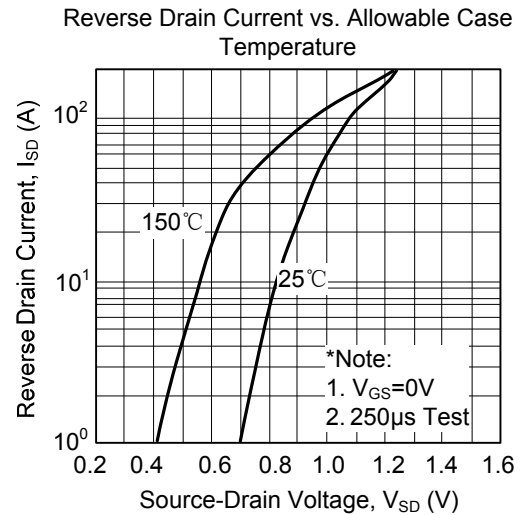
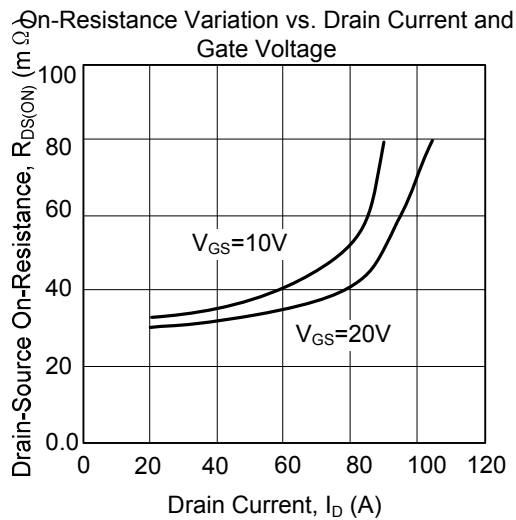
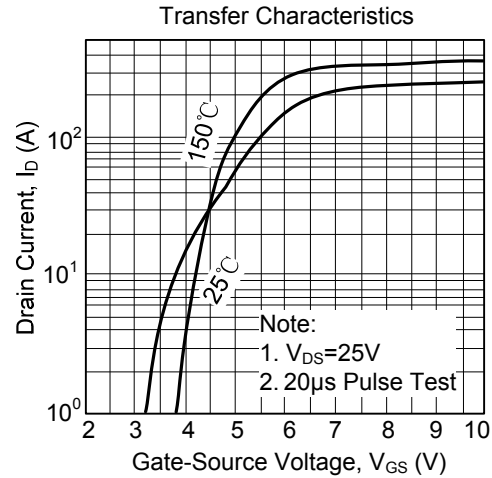
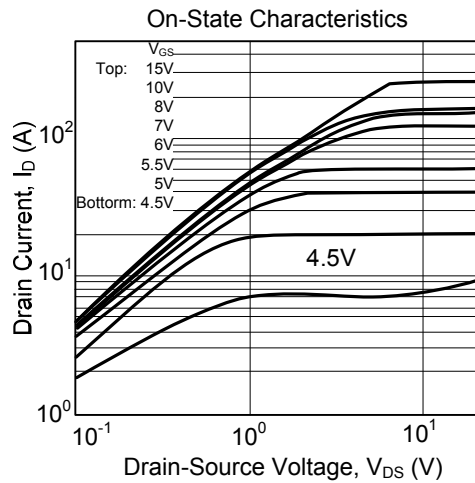
■ ELECTRICAL CHARACTERISTICS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0 V, I _D = 250 μA	60			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} = 20V, V _{DS} = 0 V			100	nA
	Reverse		V _{GS} = -20V, V _{DS} = 0 V			-100	nA
Breakdown Voltage Temperature Coefficient		ΔBV _{DSS} /ΔT _J	I _D =250μA, Referenced to 25°C		0.06		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250 μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10 V, I _D = 15 A		32	40	mΩ
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1MHz		800		pF
Output Capacitance		C _{OSS}			300		pF
Reverse Transfer Capacitance		C _{RSS}			80		pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		t _{D(ON)}	V _{DD} = 30V, I _D =15 A, V _{GS} =10V (Note 1, 2)		12		ns
Turn-On Rise Time		t _R			79		ns
Turn-Off Delay Time		t _{D(OFF)}			50		ns
Turn-Off Fall Time		t _F			52		ns
Total Gate Charge		Q _G	V _{DS} = 60V, V _{GS} = 10 V, I _D = 24A (Note 1, 2)		20	30	nC
Gate-Source Charge		Q _{GS}			6		nC
Gate-Drain Charge		Q _{GD}			9		nC
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} = 0 V, I _S = 30A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current		I _S				30	A
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}				120	A

Notes: 1. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

Peak Diode Recovery dv/dt Test Circuit

Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)

Switching Test Circuit

Switching Waveforms

Gate Charge Test Circuit

Gate Charge Waveform

Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS


TYPICAL CHARACTERISTICS(Cont.)
